

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



## Contact us

Tel: +86-755-8981 8866 Fax: +86-755-8427 6832

Email & Skype: info@chipsmall.com Web: www.chipsmall.com

Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China







### 1N5908 SM5908

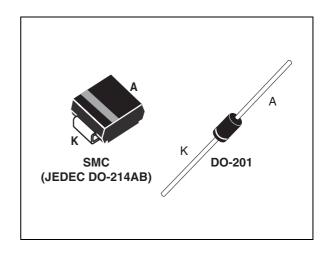
### Transil™

#### **Features**

- Peak pulse power:
  - 1500 W (10/1000 μs)
- Stand off voltage: 5 V
- Unidirectional
- Operating T<sub>i max</sub>: 175 °C
- High power capability at T<sub>i max</sub>:
  - 1500 W (10/1000 μs)
- JEDEC registered package outline

#### Complies with the following standards

- IEC 61000-4-2 level 4:
  - 15 kV (air discharge)
  - 8 kV (contact discharge)
- IEC 61000-4-5
- MIL STD 883G, method 3015-7 Class 3B
  - 25 kV HBM (human body model)
- Resin meets UL 94, V0
- MIL-STD-750, method 2026 solderability
- EIA STD RS-481 and IEC 60286-3 packing
- IPC 7531 footprint



#### **Description**

This Transil series has been designed to protect sensitive equipment against electrostatic discharges according to IEC 61000-4-2, and MIL STD 883, method 3015, and electrical over stress according to IEC 61000-4-4 and 5. These devices are more generally used against surges below 1500 W (10/1000 µs).

The Planar technology makes it compatible with high-end equipment and SMPS where low leakage current and high junction temperature are required to provide reliability and stability over time.

They are packaged in SMC (SMC footprint in accordance with IPC 7531 standard) and DO-201.

TM: Transil is a trademark of STMicroelectroniocs

Characteristics 1N5908, SM5908

### 1 Characteristics

Table 1. Absolute maximum ratings  $(T_{amb} = 25 \, ^{\circ}C)$ 

Symbol	Parameter	Value	Unit	
P <sub>PP</sub>	Peak pulse power dissipation (1)	$T_j$ initial = $T_{amb}$	1500	W
T <sub>stg</sub>	Storage temperature range	-65 to +175	° C	
Tj	Operating junction temperature range	-55 to +175	° C	
T <sub>L</sub>	Maximum lead temperature for soldering during 10 s.	260	° C	

<sup>1.</sup> For a surge greater than the maximum values, the diode will fail in short-circuit.

Table 2. Thermal resistances

Symbol	Parameter	Value	Unit	
D	Junction to leads	SMC	15	
$R_{th(j-l)}$	ounction to leads	DO-201	20	° C/W
R <sub>th(j-a)</sub>	Junction to ambient on printed circuit on recommended pad layout		90	C/VV
	Junction to ambient	DO-201	75	

Figure 1. Electrical characteristics - definitions

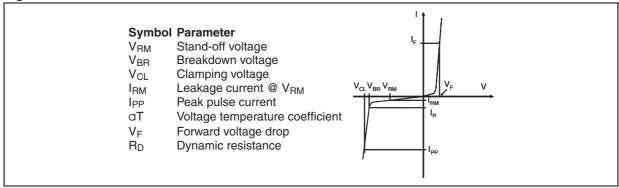
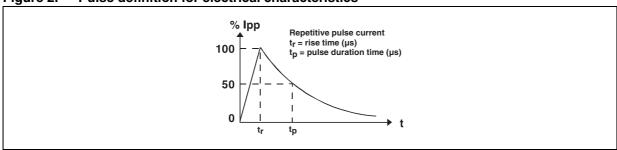


Figure 2. Pulse definition for electrical characteristics



1N5908, SM5908 Characteristics

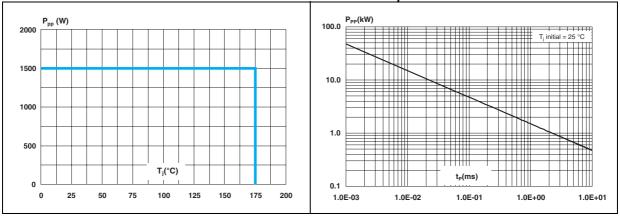
Table 3.	Electrical characteristics - parameter values (T <sub>amb</sub> = 25 °C)

	I <sub>RM</sub> @V <sub>RM</sub> V		V <sub>BR</sub> @	V <sub>BR</sub> @I <sub>R</sub> <sup>(1)</sup>		V <sub>CL</sub> @I <sub>PP</sub> , 10/1000 μs		V <sub>CL</sub> @I <sub>PP</sub> , 10/1000 μs		@I <sub>PP</sub> , 00 µs	α <b>T</b> <sup>(2)</sup>	С
Order code	max		min		max		max		max		max	typ
	μΑ	V	V	mA	V	A <sup>(3)</sup>	V	A <sup>(3)</sup>	V	A <sup>(3)</sup>	10-4/ °C	pF
1N5908	300	5	6	1	7.6	30	8	60	8.5	120	5.7	9500
SM5908	300	3	U	'	7.0	30	O	00	0.5	120	5.7	3300

- 1. Pulse tes:  $t_p < 50 \text{ ms}$
- 2. To calculate V<sub>BR</sub> or V<sub>CL</sub> versus junction temperature, use the following formulas: V<sub>BR</sub> @ T<sub>J</sub> = V<sub>BR</sub> @ 25°C x (1 +  $\alpha$ T x (T<sub>J</sub> 25)) V<sub>CL</sub> @ T<sub>J</sub> = V<sub>CL</sub> @ 25°C x (1 +  $\alpha$ T x (T<sub>J</sub> 25))
- 3. Surge capability given for both directions

Figure 3. Peak pulse power dissipation versus initial junction temperature

Figure 4. Peak pulse power versus exponential pulse duration (T<sub>i</sub> initial = 25 °C)



Characteristics 1N5908, SM5908

Figure 5. Clamping voltage versus peak pulse current (exponential waveform, typical values)

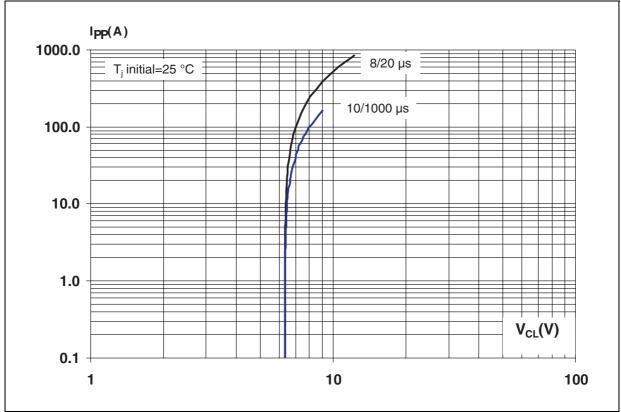
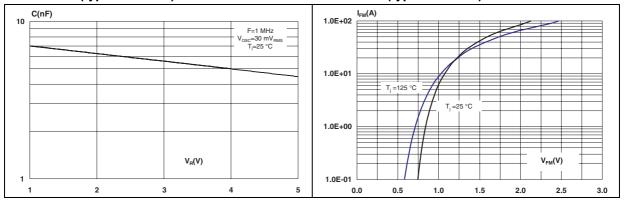


Figure 6. Junction capacitance versus reverse applied voltage (typical values)

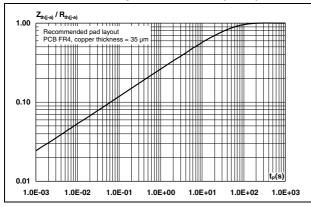
Figure 7. Peak forward voltage drop versus peak forward current (typical values)



1N5908, SM5908 Characteristics

Figure 8. Relative variation of thermal impedance, junction to ambient, versus pulse duration (SMC)

Figure 9. Relative variation of thermal impedance, junction to ambient, versus pulse duration (DO-201)



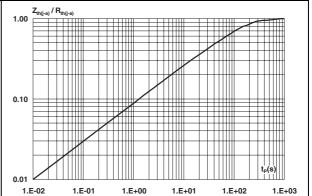
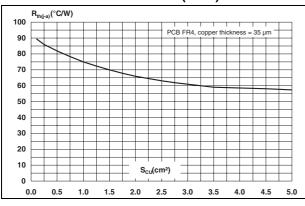
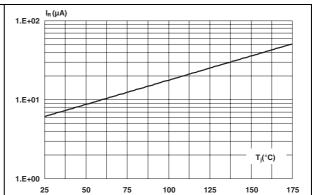


Figure 10. Thermal resistance junction to ambient versus copper surface under each lead (SMC)

Figure 11. Leakage current versus junction temperature (typical values)





Package information 1N5908, SM5908

### 2 Package information

- Case: JEDEC DO-214AB molded plastic over planar junction
- Terminals: solder plated, solderable per MIL-STD-750, Method 2026
- Polarity: for unidirectional types the band indicates cathode
- Flammability: epoxy is rated UL94V-0
- RoHS package

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK<sup>®</sup> packages, depending on their level of environmental compliance. ECOPACK<sup>®</sup> specifications, grade definitions and product status are available at: <a href="https://www.st.com">www.st.com</a>. ECOPACK<sup>®</sup> is an ST trademark.

Table 4. SMC dimensions

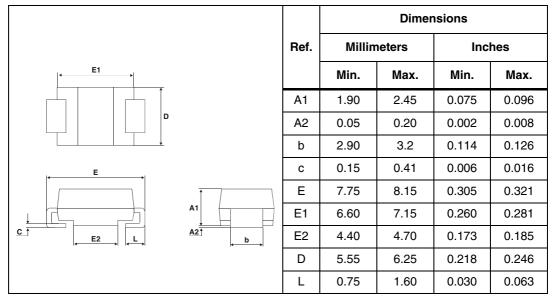
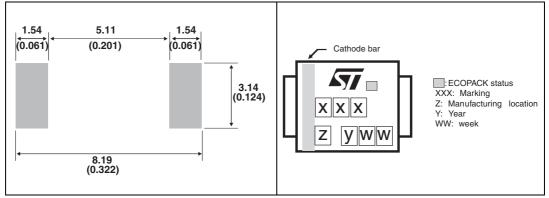


Figure 12. SMC footprint dimensions mm Figure 13. SMC marking layout<sup>(1)</sup> (inches)



1. Marking layout can vary according to assembly location.

1N5908, SM5908 Package information

Table 5. DO-201 Dimensions

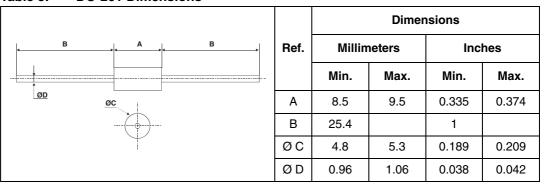
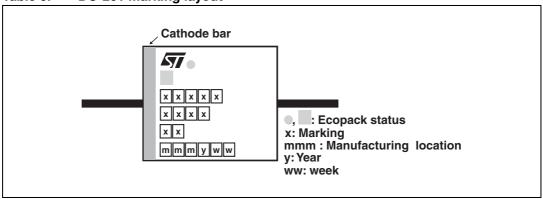


Table 6. DO-201 marking layout



# **3** Ordering information

Table 7. Ordering information

Order code	Marking	Package Weight		Base qty	Delivery mode	
SM5908	MDC	SMC	0.25 g	2500	Tape and reel	
1N5908 1N5908		DO-201	0.9 g	600	Ammopack	

# 4 Revision history

Table 8. Document revision history

Date Revision		Changes			
Aug-1999	2A	Previous release			
20-Sep-2011	3	Added cathode bands. Added standards compliance statements. Updated <i>Description</i> . Updated <i>Table 1</i> and <i>Table 2</i> . Updated Figures 3 through 11. Updated <i>Section 2: Package information</i> .			

#### Please Read Carefully:

Information in this document is provided solely in connection with ST products. STMicroelectronics NV and its subsidiaries ("ST") reserve the right to make changes, corrections, modifications or improvements, to this document, and the products and services described herein at any time, without notice.

All ST products are sold pursuant to ST's terms and conditions of sale.

Purchasers are solely responsible for the choice, selection and use of the ST products and services described herein, and ST assumes no liability whatsoever relating to the choice, selection or use of the ST products and services described herein.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted under this document. If any part of this document refers to any third party products or services it shall not be deemed a license grant by ST for the use of such third party products or services, or any intellectual property contained therein or considered as a warranty covering the use in any manner whatsoever of such third party products or services or any intellectual property contained therein.

UNLESS OTHERWISE SET FORTH IN ST'S TERMS AND CONDITIONS OF SALE ST DISCLAIMS ANY EXPRESS OR IMPLIED WARRANTY WITH RESPECT TO THE USE AND/OR SALE OF ST PRODUCTS INCLUDING WITHOUT LIMITATION IMPLIED WARRANTIES OF MERCHANTABILITY, FITNESS FOR A PARTICULAR PURPOSE (AND THEIR EQUIVALENTS UNDER THE LAWS OF ANY JURISDICTION), OR INFRINGEMENT OF ANY PATENT, COPYRIGHT OR OTHER INTELLECTUAL PROPERTY RIGHT.

UNLESS EXPRESSLY APPROVED IN WRITING BY TWO AUTHORIZED ST REPRESENTATIVES, ST PRODUCTS ARE NOT RECOMMENDED, AUTHORIZED OR WARRANTED FOR USE IN MILITARY, AIR CRAFT, SPACE, LIFE SAVING, OR LIFE SUSTAINING APPLICATIONS, NOR IN PRODUCTS OR SYSTEMS WHERE FAILURE OR MALFUNCTION MAY RESULT IN PERSONAL INJURY, DEATH, OR SEVERE PROPERTY OR ENVIRONMENTAL DAMAGE. ST PRODUCTS WHICH ARE NOT SPECIFIED AS "AUTOMOTIVE GRADE" MAY ONLY BE USED IN AUTOMOTIVE APPLICATIONS AT USER'S OWN RISK.

Resale of ST products with provisions different from the statements and/or technical features set forth in this document shall immediately void any warranty granted by ST for the ST product or service described herein and shall not create or extend in any manner whatsoever, any liability of ST.

ST and the ST logo are trademarks or registered trademarks of ST in various countries.

Information in this document supersedes and replaces all information previously supplied.

The ST logo is a registered trademark of STMicroelectronics. All other names are the property of their respective owners.

© 2011 STMicroelectronics - All rights reserved

STMicroelectronics group of companies

Australia - Belgium - Brazil - Canada - China - Czech Republic - Finland - France - Germany - Hong Kong - India - Israel - Italy - Japan - Malaysia - Malta - Morocco - Philippines - Singapore - Spain - Sweden - Switzerland - United Kingdom - United States of America

www.st.com



Doc ID 2914 Rev 3 9/9